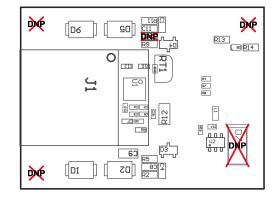
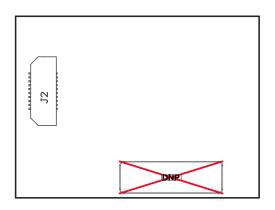
ZZ1 Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00650	REV: E1	SVN REV	: Not In VersionControl
	TID #: TIDA-00650			
PLOT NAME = Top Assembly Drawing	GENERATED : 9/16/201	15 4:51:50	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00650 REV: E1	SVN REV: Not In VersionControl
	TID #: TIDA-00650	
PLOT NAME = Bottom Assembly Drawing	GENERATED : 9/16/2015 4:51:50	PM TEXAS INSTRUMENTS

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